

T-29-21

MAXIMUM RATINGS

Rating	Symbol	PBF493R,RS	Unit
Collector-Emitter Voltage	V _{CEO}	300	Vdc
Collector-Base Voltage	V _{CBO}	300	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector Current - Continuous	I _C	500	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	Watt mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{Stg}	-55 to +150	°C

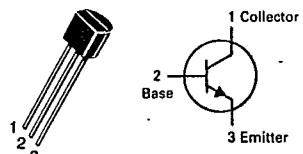
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THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	83.3	°C/W
Thermal Resistance, Junction to Ambient	R _{θJC}	200	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (1) (I _C = 3.0 mAdc, I _B = 0)	V _{(BR)CEO}	300	—	Vdc
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	300	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 100 μAdc, I _C = 0)	V _{(BR)EBO}	5.0	—	Vdc
Collector Cutoff Current (V _{CB} = 250 Vdc, I _E = 0)	I _{CBO}	—	50	nAdc
Emitter Cutoff Current (V _{EB} = 3.0 V)	I _{EBO}	—	20	nAdc
Collector Cutoff Current (V _{CE} = 10 V)	I _{CEO}	—	50	nAdc
ON CHARACTERISTICS (1)				
DC Current Gain (I _C = 20 mAdc, V _{CE} = 10 Vdc) (I _C = 1.0 mAdc, V _{CE} = 10 Vdc) (I _C = 30 mAdc, V _{CE} = 10 Vdc)	PBF259RS All Types All Types	h _{FE} 60 25 25	— — —	—
Collector-Emitter Saturation Voltage (I _C = 30 mAdc, I _B = 1.5 mAdc) (I _C = 30 mAdc, I _B = 60 mAdc)	V _{CE(sat)}	— —	0.5 1.0	Vdc
Base-Emitter Saturation Voltage (I _C = 20 mA, I _B = 2.0 mA)	V _{BE(sat)}	—	0.9	V
SMALL-SIGNAL CHARACTERISTICS				
Current-Gain Bandwidth Product (I _C = 10 mAdc, V _{CE} = 10 Vdc, f = 20 MHz)	f _T	40	—	MHz
Output Capacitance (V _{CB} = 20 Vdc, I _E = 0, f = 1.0 MHz)	C _{obo}	—	3.0	pF

PBF259R, RSCASE 29-04, STYLE 17
TO-92 (TO-226AA)**HIGH VOLTAGE TRANSISTORS**

NPN SILICON

Refer to MPSA92 for graphs.